Preferred Device

# **Sensitive Gate Triacs**

## **Silicon Bidirectional Thyristors**

Designed primarily for industrial and consumer applications for full wave control of ac loads such as appliance controls, heater controls, motor controls, and other power switching applications.

## Features

- Pb–Free Packages are Available
- Sensitive Gate Triggering in 3 Modes for AC Triggering on Sinking Current Sources
- Four Mode Triggering for Drive Circuits that Source Current
- All Diffused and Glass–Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance and High Heat Dissipation
- Center Gate Geometry for Uniform Current Spreading

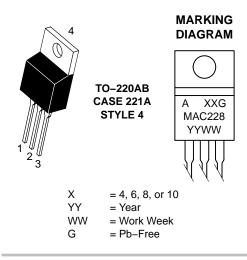


## ON Semiconductor®

http://onsemi.com

## TRIACS 8 AMPERES RMS 200 – 800 VOLTS





#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MAC228A4	TO-220	500 Units/Box
MAC228A6	TO-220	500 Units/Box
MAC228A8	TO-220	500 Units/Box
MAC228A8G	TO-220 (Pb-Free)	500 Units/Box
MAC228A10	TO-220	500 Units/Box
MAC228A10G	TO-220 (Pb-Free)	500 Units/Box

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Value	Unit
Peak Repetitive Off–State Voltage <sup>,</sup> (Note 1) (T <sub>J</sub> = -40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open)	MAC228A4 MAC228A6 MAC228A8 MAC228A10	V <sub>drm,</sub> V <sub>rrm</sub>	200 400 600 800	V
On-State RMS Current, ( $T_C = 80^{\circ}C$ ) – Full Cycle Sine Wave 50	) to 60 Hz	I <sub>T(RMS)</sub>	8.0	А
Peak Non–Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T <sub>J</sub> = 110°C)		I <sub>TSM</sub>	80	A
Circuit Fusing Considerations, (t = 8.3 ms)		l <sup>2</sup> t	26	A <sup>2</sup> s
Peak Gate Current, (t $\leq$ 2 µs, T <sub>C</sub> = 80°C)		I <sub>GM</sub>	±2.0	А
Peak Gate Voltage, (t $\leq$ 2 µs, T <sub>C</sub> = 80°C)		V <sub>GM</sub>	±10	V
Peak Gate Power, (t $\leq$ 2 µs, T <sub>C</sub> = 80°C)		P <sub>GM</sub>	20	W
Average Gate Power, (t $\leq$ 8.3 ms, T <sub>C</sub> = 80°C)		P <sub>G(AV)</sub>	0.5	W
Operating Junction Temperature Range		TJ	-40 to 110	°C
Storage Temperature Range		T <sub>stg</sub>	-40 to 150	°C
Mounting Torque		-	8.0	in lb

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

damage may occur and reliability may be affected.
V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Case	$R_{\theta JC}$	2.0	°C/W
Thermal Resistance – Junction-to-Ambient		62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	ΤL	260	°C

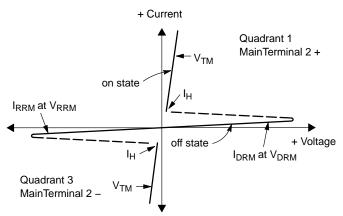
**ELECTRICAL CHARACTERISTICS** ( $T_c = 25^{\circ}C$  unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Peak Repetitive Blocking Current, (V <sub>D</sub> = Rated V <sub>DRM</sub> , V <sub>RRM</sub> ; Gate Open) $T_J = 25^{\circ}C$ $T_J = 110^{\circ}C$	I <sub>DRM</sub> , I <sub>RRM</sub>		-	10 2.0	μA mA
ON CHARACTERISTICS	-	-	-	-	
Peak On-State Voltage, (I <sub>TM</sub> = $\pm$ 11 A Peak, Pulse Width $\leq$ 2 ms, Duty Cycle $\leq$ 2%)	V <sub>TM</sub>	-	-	1.8	V
Gate Trigger Current (Continuous DC), (V <sub>D</sub> = 12 V, R <sub>L</sub> = 100 Ω) MT2(+), G(+); MT2(+), G(-); MT2(-), G(-) MT2(-), G(+)	I <sub>GT</sub>			5.0 10	mA
Gate Trigger Voltage (Continuous DC), (V <sub>D</sub> = 12 V, R <sub>L</sub> = 100 Ω) MT2(+), G(+); MT2(+), G(-); MT2(-), G(-) MT2(-), G(+)	V <sub>GT</sub>			2.0 2.5	V
Gate Non–Trigger Voltage (Continuous DC), (V <sub>D</sub> = 12 V, T <sub>C</sub> = 110°C, R <sub>L</sub> = 100 $\Omega$ ) All Four Quadrants	V <sub>GD</sub>	0.2	-	-	V
Holding Current, ( $V_D$ = 12 Vdc, Initiating Current = ±200 mA, Gate Open)	Iн	-	-	15	mA
Gate–Controlled Turn–On Time, ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 16 A Peak, $I_G$ = 30 mA)	t <sub>gt</sub>	-	1.5	-	μs
DYNAMIC CHARACTERISTICS					

Critical Rate of Rise of Off-State Voltage, ( $V_D$ = Rated V <sub>DRM</sub> , Exponential Waveform, T <sub>C</sub> = 110°C)		-	25	-	V/µs
Critical Rate of Rise of Commutation Voltage, (V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 11.3 A, Commutating di/dt = 4.1 A/ms, Gate Unenergized, T <sub>C</sub> = 80°C)	dv/dt(c)	-	5.0	-	V/µs

#### Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
Ι <sub>Η</sub>	Holding Current



#### MT2 POSITIVE (Positive Half Cycle) (+) MT2 (+) MT2 Quadrant II (+) I<sub>GT</sub> GATE Quadrant I (–) I<sub>GT</sub> GATE 0 0 <u>ф</u>мт1 **ф** МТ1 Ξ Ξ REF REF I<sub>GT</sub> + I<sub>GT</sub> (–) MT2 (–) MT2 Quadrant III (+) I<sub>GT</sub> GATE **Quadrant IV** (-) I<sub>GT</sub> 0 o **ф** МТ1 MT1 Ξ Ξ REF REF MT2 NEGATIVE (Negative Half Cycle)

#### **Quadrant Definitions for a Triac**

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

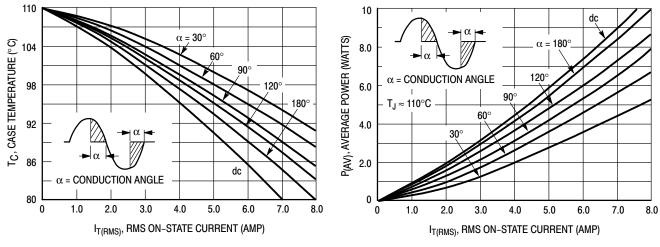
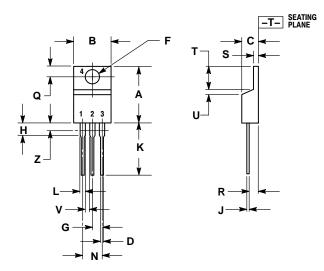


Figure 1. RMS Current Derating

Figure 2. On-State Power Dissipation

#### PACKAGE DIMENSIONS

TO-220 PLASTIC CASE 221A-09 **ISSUE AA** 



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIME	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04
Z TYLE	 4: 1. Main 2. Main			

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